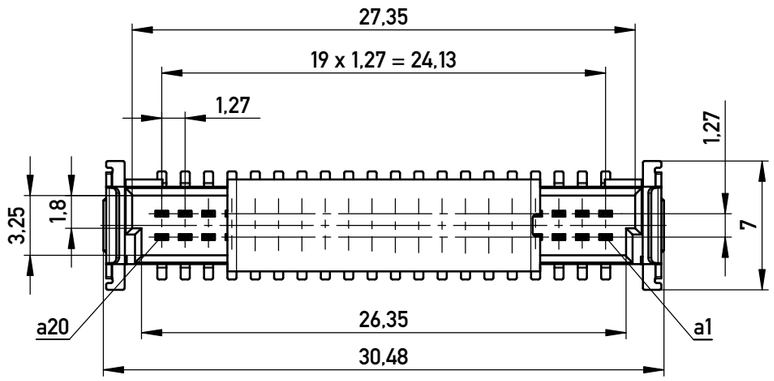
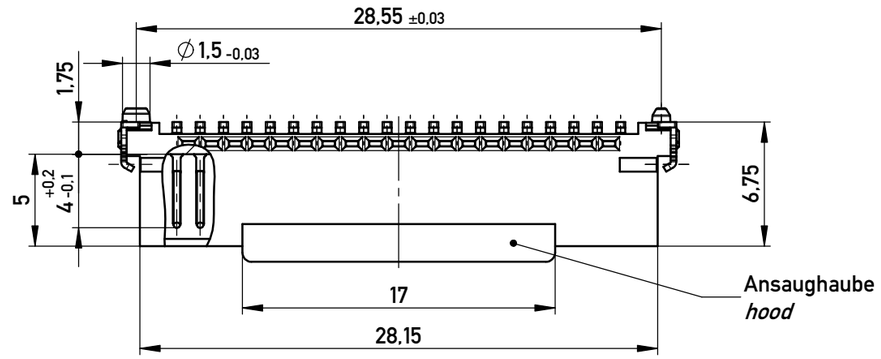
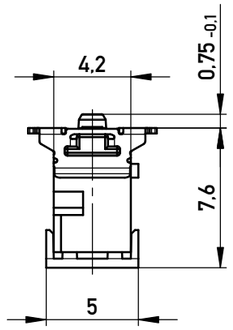








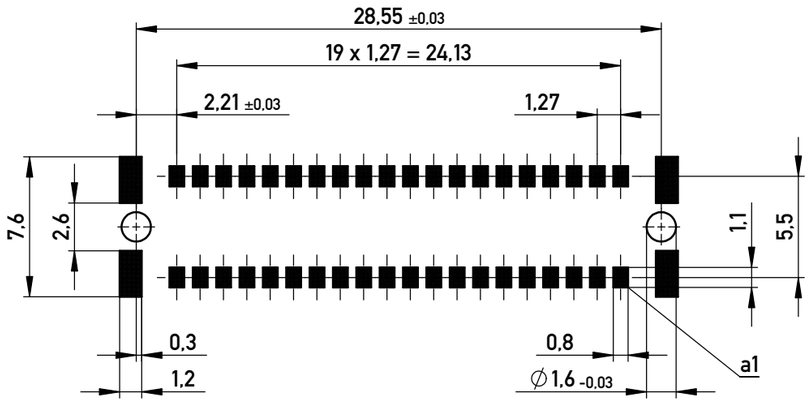
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

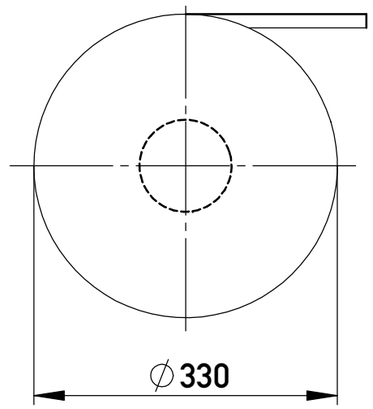
Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

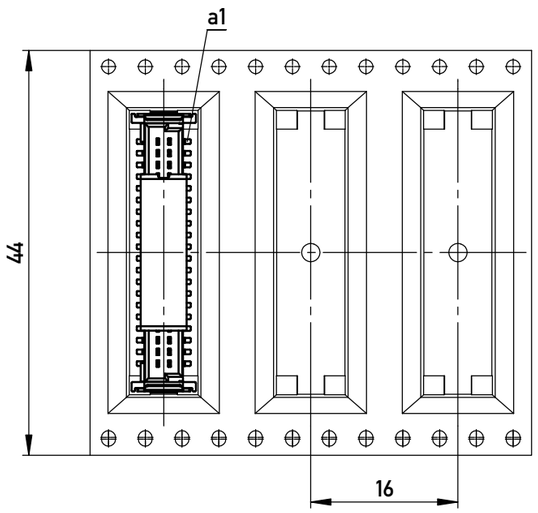
Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



Abspulrichtung - *Reel off Direction*



BA 8-13 - 8mm Bauhöhe
type 8-13 - Low Profile

Information:

Tolerances

All Dimensions in mm

Scale 3:1

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Subject to modification without prior notice.
Drawing will not be updated.

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Designation
Messerl. SMC-Q 40-SMD-BA8-13
Male SMC-Q 40-SMD-type8-13

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A3

Index		Date	
e		25.07.2016	

Class SMCQ